SPECIFICATION FOR LCD MODULE

Model No. TM12864ABC

Prepared by:	Date:
Checked by:	Date:
Verified by :	Date:
Approved	Date:

TIANMA MICROELECTRONICS CO., LED

REVISION RECORD

Date	Ref. Page	Revision No.	Revision Items	Check & Approval

1. General Specifications:

1.1 Display type: STN

1.2 Display color*:

Display color: Blue-Black

Background: Yellow

1.3 Polarizer mode: Transflective/Positive

1.4 Viewing Angle: 6:00

1.5 Driving Method: 1/64 Duty 1/9 Bias

1.6 Backlight: LED

1.7 Controller: HD61202UFS

1.8 Data Transfer: 8 Bit Parallel

1.9 Operating Temperature: -25----+60 ℃

Storage Temperature: -30----+70 °C

1.10 Outline Dimensions: Refer to outline drawing on next page

1.11 Dot Matrix: 128 X 64 Dots

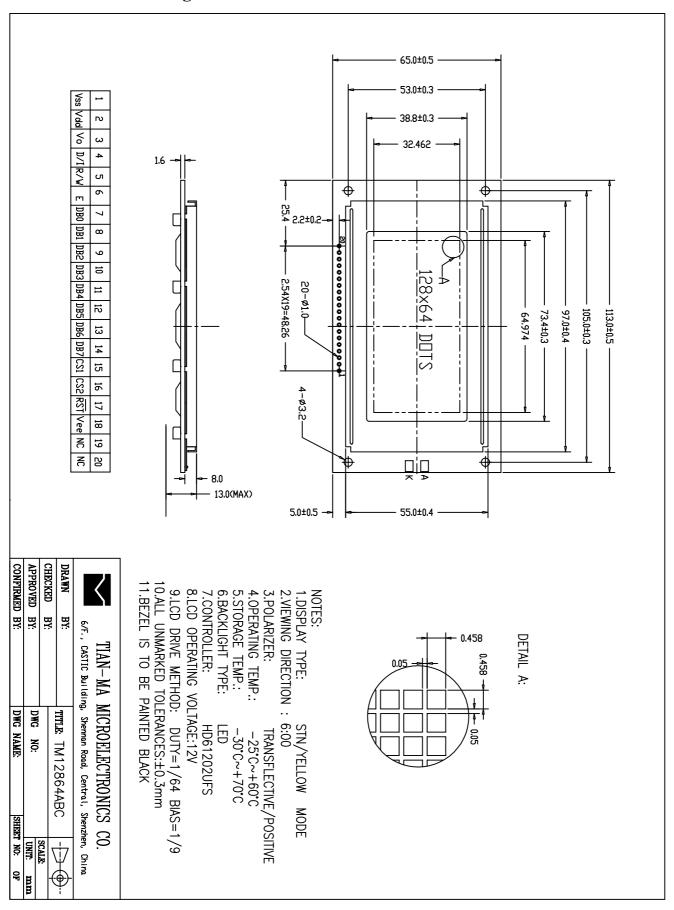
1.12 Dot Size: 0.458 X 0.458(mm)

1.13 Dot Pitch: 0.508 X 0.508(mm)

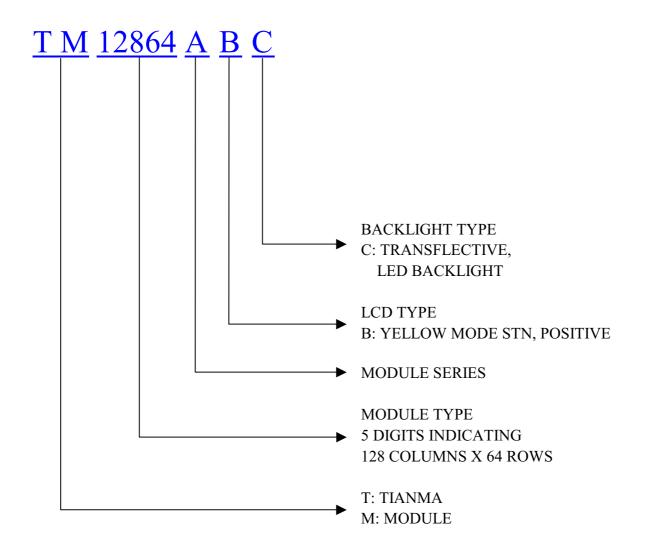
1.14 Weight: 95g

^{*} Color tone is slightly changed by temperature and driving voltage.

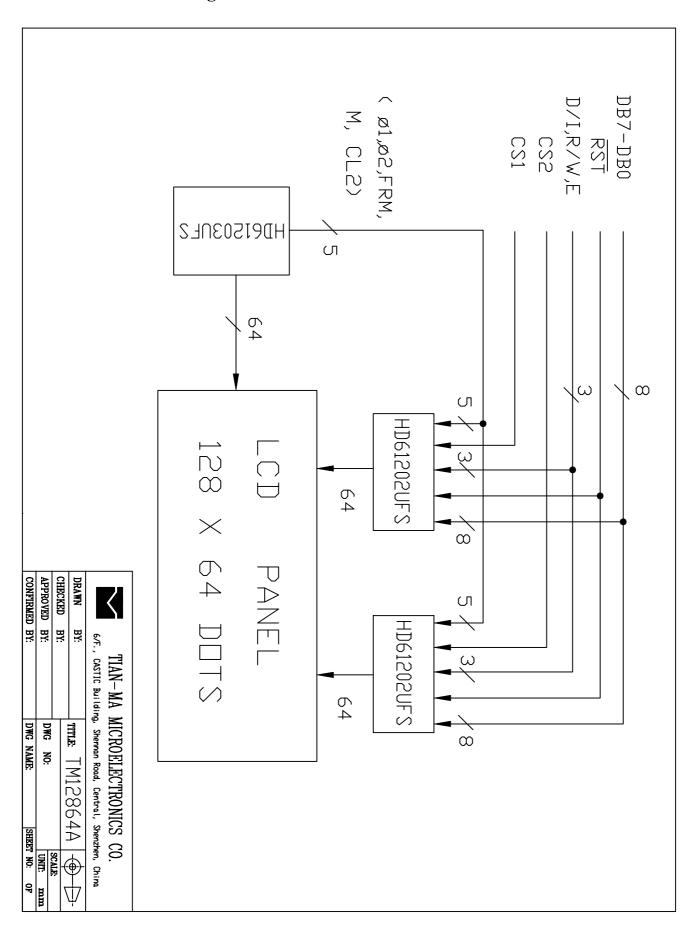
2. Outline Drawing



3. LCD Module Part Numbering System



4. Circuit Block Diagram



5. Absolute Maximum Ratings

Item	Symbol	Min.	Max.	Unit	Remark	
Power Supply Voltage	V _{DD} -V _{SS}	-0.3	6.0	V		
LCD Driving Voltage	V _{LCD}	-	25.0	v		
Operating Temperature Range	Тор	-25	+60	°C	No	
Storage Temperature Range	Тѕт	-30	+70		Condensation	

6. Electrical Specifications and Instruction Code

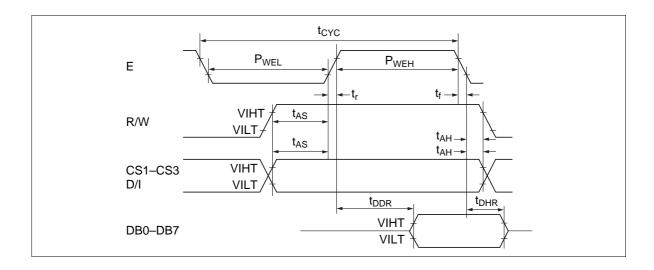
6.1 Electrical characteristics

Iten	n	Symbol	Min.	Тур.	Max.	Unit
Supply V (Log	_	V _{DD} -V _{SS}	4.75	5.0	5.25	V
Supply V (LCD D	_	Vlcd	-	12.0	-	V
Input	High	$V_{\text{\tiny IH}}$ $(V_{\text{DD}}=5.0)$	$0.8 m V_{DD}$	-	V _{DD} +0.3	V
Signal Voltage	Low	$V_{\text{\tiny IL}}$ $(V_{\text{DD}}=5.0)$	0	-	$0.2 \mathrm{V}_\mathrm{DD}$	V
Supply c		I_{DD} $(V_{DD}=5.0)$	-	2.5	-	mA
Supply c (LCD E		$ m I_{EE}$	-	2.2	-	mA
Supply c		$I_{ ext{dd}}$ $(V_{ ext{LED}}=4.2)$	-	-	260	mA

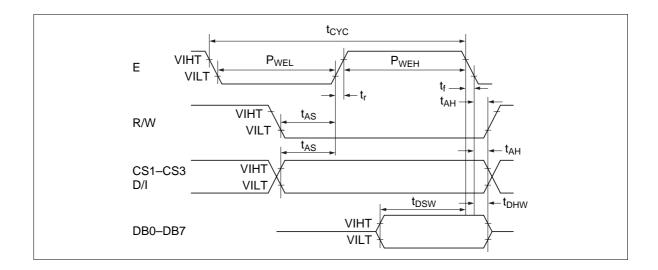
6.2 Interface Signals

Pin No.	Symbol	Level	Description
1	V_{SS}	0V	Ground
2	$V_{ m DD}$	5.0V	Power supply voltage for logic and LCD(+)
3	$V_{\rm O}$	-7.0V	Operating voltage for LCD(-) (variable)
4	D/I	H/L	Selects Data or Instruction
5	R/W	H/L	Selects read or write
6	E	H/L	Read and write enable signal
7	DB0	H/L	Data bit0
8	DB1	H/L	Data bit1
9	DB2	H/L	Data bit2
10	DB3	H/L	Data bit3
11	DB4	H/L	Data bit4
12	DB5	H/L	Data bit5
13	DB6	H/L	Data bit6
14	DB7	H/L	Data bit7
15	CS1	H/L	When CS1=1,CS2=0 select the chip U2 (active)
16	CS2	H/L	When CS1=0,CS2=1 select the chip U1 (active)
17	RST	H/L	Reset signal (Active at low)
18	$V_{ ext{EE}}$	≤-10.0V	Negative voltage for LCD driving
19	NC	-	No signal
20	NC	-	No signal
Α	-	4.2V	Supply voltage for LED(+)
K	-	0V	Supply voltage for LED(-)

6.3 Interface Timing Chart



CPU Read Timing



CPU Write Timing

AC Characteristics

MPU Interface (GND = 0V, V_{CC} = 2.7 to 5.5V, Ta = -30 to +75°C)*

Item	Symbol	Min	Тур	Max	Unit
E cycle time	t _{cyc}	1000	_	_	ns
E high level width	P _{WEH}	450	_	_	ns
E low level width	P_{WEL}	450	_	_	ns
E rise time	t _r	_	_	25	ns
E fall time	t _f	_	_	25	ns
Address setup time	t _{AS}	140	_	_	ns
Address hold time	t _{AH}	10	_	_	ns
Data setup time	t _{DSW}	200	_	_	ns
Data delay time	t _{DDR}	_	_	320	ns
Data hold time (write)	t _{DHW}	10	_	_	ns
Data hold time (read)	t _{DHR}	20	_	_	ns

6.4 Instruction Code

					ၓ	Code						
Instructions	R/W	D/I	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Functions	
Display on/off	0	0	0	0	1	_	_	1	1	1/0	Controls display on/off. RAM data and internal status are not affected. 1: on, 0: off.	M data and internal n, 0: off.
Display start line	0	0	_	_	Disple	Display start line (0–63)	line (0-	-63)			Specifies the RAM line displayed at the top of the screen.	layed at the top of the
Set page (X address)	0	0	~	0	-	-	-	Page (0–7)	(2-0)		Sets the page (X address) of RAM at the page (X address) register.	of RAM at the page
Set Y address	0	0	0	1	Y add	Y address (0–63)	-63)				Sets the Y address in the Y address counter.	address counter.
Status read	_	0	Busy	0	NO No	Reset 0	0	0	0	0	Reads the status.	
					0						RESET 1: Reset 0: Normal	
											ON/OFF 1: Display off 0: Display on	
											Busy 1: Internal operation 0: Ready	tion
Write display data	0	-	Write data	data							Writes data DB0 (LSB) F to DB7 (MSB) on the data bus into display F RAM.	Has access to the address of the display RAM specified in advance. After the
Read display data	_	-	Read data	data							Reads data DB0 (LSB) to DB7 (MSB) from the display RAM to the data bus.	access, Y address is increased by 1.
	17.	,	`		,	-						

Note: Busy time varies with the frequency (f_{CLK}) of Ø1, and Ø2. $(1/f_{CLK} \le T_{BUSY} \le 3/f_{CLK})$

7. Optical Characteristics

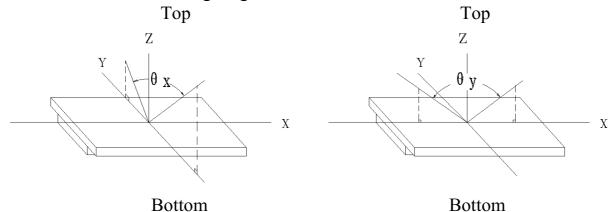
7.1 Optical Characteristics

T	a=	=2	5	$^{\circ}$ C
1	a^-		J	\sim

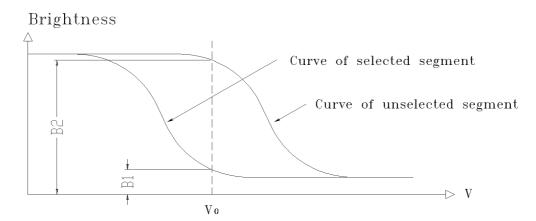
Item	l	Symbol	Cone	dition	Min.	Тур.	Max.	Unit
Viewing	A .a a 1 a	$\theta_{\mathbf{x}}$	C > 2	θ _y =0°	-30		20	Dag
Viewing A	Angle	θу	Cr≥2	θ _x =0°	-30)	30	Deg
Contrast Ratio		Cr	$\theta_{\mathbf{x}} = \theta_{\mathbf{y}} = 0$	=0°	3.0	-	-	
Response	Turn on	Ton	$\theta_{\mathbf{x}} =$	=0°	-	-	300	***************************************
Time	Turn off	Toff	θ_{y} =	=0°	-	-	300	ms

7.2 Definition of Optical Characteristics

7.2.1 Definition of Viewing Angle



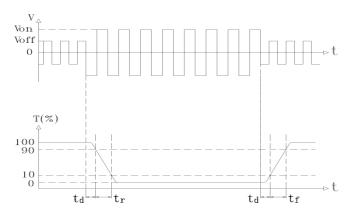
7.2.2 Definition of Contrast Ratio



Contrast Ratio =
$$B2/B1 = \frac{\text{unselected state brightness}}{\text{selected state brightness}}$$

Measuring Conditions:

1) Ambient Temperature: 25°C; 2) Frame frequency: 70Hz 7.2.3 Definition of Response time



Turn on time: $t_{on} = t_d + t_r$ Turn off time: $t_{off} = t_d + t_f$ Measuring Condition:

1) LCD Operating Voltage: 12.0V 2) Frame frequency: 70Hz

8. Reliability

8.1 Content of Reliability Test

Ta=25°C

	<u> </u>		
No.	Test Item	Content of Test	Test condition
1	High Temperature	Endurance test applying the high	70 ℃
	Storage	storage temperature for a long time	240H
2	Low Temperature	Endurance test applying the low	-30°C
	Storage	storage temperature for a long time	240H
		Endurance test applying the	
3	High Temperature	electric stress (voltage & current)	60°C
3	Operation	and the thermal stress to the	240H
		element for a long time	240Π
	Low Temperature	Endurance test applying the	-25°C
4	Operation	electric stress under low	240H
	Орегиноп	temperature for a long time	
	High Temperature	Endurance test applying the high	50°C
5	/Humidity Storage	temperature and high humidity	95%RH
	Trainially Storage	storage for a long time	240H
		Endurance test applying the low	
	T	and high temperature cycle	20°C /70°C
6	Temperature	$-30^{\circ}\text{C} \longleftrightarrow 25^{\circ}\text{C} \longleftrightarrow 70^{\circ}\text{C} \longleftrightarrow 25^{\circ}\text{C}$	-30°C/70°C
	Cycle	30min 5min 30min 5min ←———————————————————————————————————	10 cycles
		1 cycle	
	N. T. and T. and	F. 1	10Hz~500Hz,
7	Vibration Test	Endurance test applying the	100m/s^2 ,
	(package state)	vibration during transportation	120min
	Shock Test	Endurance test applying the shock	Half- sine wave,
8	(package state)	during transportation	300m/s^2 ,
	(Package State)	Ç 1	18ms
	Atmospheric	Endurance test applying the	25kPa
9	Pressure Test	atmospheric pressure during	25Ki a 16H
		transportation by air	1011

8.2 Failure Judgment Criterion

Criterion			To	est	Iter	n N	0.			Failure Judgement Criterion	
Item	1	2	3	4	5	6	7	8	9	ranure Judgement Criterion	
Basic Specification	1	V	1	1	1	V	V	√	V	Out of the basic Specification	
Electrical specification	V	V	1	1	V					Out of the electrical specification	
Mechanical Specification							1	√		Out of the mechanical specification	
Optical Characteristic	V	V	1	1	1	1			√	Out of the optical specification	
Note	Fo	or te	est i	ten	n re	fer	to 8	3.1			
Remark			sp fica			atio	n =	= (Opti	ical specification + Mechanical	

9. QUALITY LEVEL

Examination	At T _a =25°C		Inspection					
or Test	(unless otherwise stated)	Min.	Max.	Unit	IL	AQL		
External Visual Inspection	Under normal illumination and eyesight condition, the distance between eyes and LCD is 25cm.	See Ap	pendix A		II	Major 1.0 Minor 2.5		
Display Defects	Under normal illumination and eyesight condition, display on inspection.	See Ap	pendix B		II	Major 1.0 Minor 2.5		

Note: Major defects: Open segment or common, Short, Serious damages, Leakage

Miner defects: Others

Sampling standard conforms to GB2828

10. Precautions for Use of LCD Modules

- 10.1 Handling Precautions
- 10.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 10.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 10.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 10.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 10.1.5 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
 - Isopropyl alcohol
 - Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketone
- Aromatic solvents
- 10.1.6 Do not attempt to disassemble the LCD Module.
- 10.1.7 If the logic circuit power is off, do not apply the input signals.
- 10.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - a. Be sure to ground the body when handling the LCD Modules.
 - b. Tools required for assembly, such as soldering irons, must be properly ground.
 - c. To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
 - d. The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

10.2 Storage precautions

- 10.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 10.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature: $0^{\circ}\text{C} \sim 40^{\circ}\text{C}$

Relatively humidity: ≤80%

- 10.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.
- 10.3 The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.

Appendix AInspection items and criteria for appearance defects

Items	Contents	Criteria				
Leakage		Not permitted				
Rainbow		According to the limit specimen				
Polarizer	Wrong polarizer attachment	Not permitted				
	Bubble between polarizer and glass	Not counted		Max. 3 defects allowed		
		ф<0.3mm	0.3mm≤¢≤0.5r		nm	
	Scratches of polarizer	According to the limit specimen				
Black spot (in viewing area)		Not counted	Max	Max. 3 spots allowed		
		X<0.2mm			Max. 3	
		X=(a+b)/2			spots (lines)	
Black line (in viewing area)	t b	Not counted	Max. 3 lines allowed		allowed	
		a<0.02mm	0.021	0.02mm≤a≤0.05mm b≤2.0mm		
Progressive cracks		Not permitted				

Appendix BInspection items and criteria for display defects

Items		Contents	Criteria			
Open segment or open common			Not permitted			
Short			Not permitted			
Wrong viewing angle			Not permitted			
Contrast radio uneven			According to the limit specimen			
Crosstalk			According to the limit specimen			
		<u> </u>	Not counted	Max.3 dots allowed		
Pin holes and cracks in segment (DOT)		X<0.1mm	0.1mm≤X≤0.2mm	-		
		X=(a+b)/2		Max.3 dots		
	- D	Not counted	Max.2 dots allowed	allowed		
		A<0.1mm	0.1mm≤A≤0.2mm D<0.25mm			
Black spot (in viewing area)			Not counted	Max.3 spots allowed		
	Q Q	X<0.1mm	0.1mm≤X≤0.2mm			
		X=(a+b)/2		Max.3 spots		
Black line (in viewing area)	b b	Not counted	Max.3 lines allowed	(lines) allowed		
		a<0.02mm	0.02mm≤a≤0.05mm b≤0.5mm			

Appendix B

Inspection items and criteria for display defects (continued)

Items	Content	Criteria			
Transformation of segment		Not counted	Max. 2 defects allowed		
		x<0.1mm	0.1mm≤x≤0.2mm		
		x=(a+b)/2			
				Max.3	
		Not counted	Max. 1 defects allowed	defects allowed	
		a<0.1mm	0.1mm≤a≤0.2mm D>0		
	-w -a	Max.2 defects 0.8W≤a≤1.2 a=measured va W=nominal va			